查询LM337供应商

捷多邦,专业PCB打样工厂,24小时加急**出路237**,LM337 3-TERMINAL ADJUSTABLE REGULATORS

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KC PACKAGE Output Voltage Range Adjustable From (TOP VIEW) -1.2 V to -37 V Output Current Capability of 1.5 A Max OUTPUT INPUT ADJUSTMEN Input Regulation Typically 0.01% Per **Input-Voltage Change** The INPUT terminal is in electrical contact with the mounting base. **Output Regulation Typically 0.3% TO-220AB** Peak Output Current Constant Over Temperature Range of Regulator **Ripple Rejection Typically 77 dB** Direct Replacement for National Semiconductor LM237 and LM337 description **KTE PACKAGE** The LM237 and LM337 are adjustable 3-terminal (TOP VIEW) negative-voltage regulators capable of supplying in excess of -1.5 A over an output voltage range OUTPUT of -1.2 V to -37 V. They are exceptionally easy to use, requiring only two external resistors to set the INPUT output voltage and one output capacitor for ADJUSTMENT frequency compensation. The current design has been optimized for excellent regulation and low The INPUT terminal is in electrical conthermal transients. In addition, the LM237 and tact with the mounting base. LM337 feature internal current limiting, thermal shutdown, and safe-area compensation, making them virtually immune to failure by overloads. Α The LM237 and LM337 serve a wide variety of applications, including local on-card regulation, programmable output-voltage regulation, and precision current regulation. The LM237 is characterized for operation over the virtual junction temperature range of -25°C to 150°C. The LM337 is characterized for operation over the virtual junction temperature range of 0°C to 125°C.

AVAILABLE OPTIONS

TJ F	PACKAGE	CHIP					
	HEAT-SINK MOUNTED (KC)	PLASTIC FLANGE MOUNTED (KTE)	FORM (Y)				
-25°C to 150°C	LM237KC	LM237KTE	—				
0°C to 125°C	LM337KC	LM337KTE	LM337Y				

The KTE package is only available taped and reeled. Add the R suffix to the device type (e.g., LM237KTER). Chip forms are tested at 25° C.

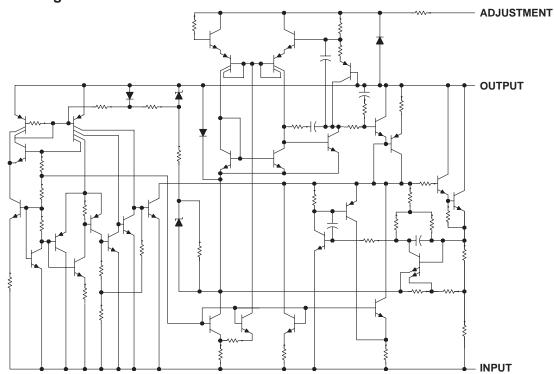


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schematic diagram



absolute maximum ratings over operating temperature ranges (unless otherwise noted)[†]

Input-to-output differential voltage, V _I – V _O	40 V
Package thermal impedance, θ_{JA} (see Notes 1 and 2): KC package	22°C/W
KTE package	23°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T _{stg}	. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability. Due to variations in individual device electrical characteristics and thermal resistance, the built-in thermal overload protection may be activated at power levels slightly above or below the rated dissipation.

2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions

	-			MIN	MAX	UNIT
Output current, I _O	$ V_I - V_O \le 40 V$,	$P \le 15 W$		10	1500	mA
	$ V_{I} - V_{O} \le 10 V$,	$P \le 15 W$		6	1500	
Operating virtual junction temperature, T			LM237	-25	150	°C
LM		LM337	0	125	C	



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electrical characteristics over recommended ranges of operating virtual junction temperature (unless otherwise noted)

DADAMETER	TEST CONDITIONS [†]		LM237			LM337				
PARAMETER			MIN	TYP	MAX	MIN	TYP	MAX	UNIT	
Input regulation‡		TJ = 25°C		0.01	0.02		0.01	0.04	%/V	
	$V_{I} - V_{O} = -3 V \text{ to } -40 V$	$T_J = MIN \text{ to MAX}$		0.02	0.05		0.02	0.07		
Ripple rejection	V _O = -10 V,	f = 120 Hz		60			60		dB	
	V _O = -10 V, f = 120 Hz,	C _{ADJ} = 10 μF	66	77		66	77			
	$I_{O} = 10 \text{ mA to } 1.5 \text{ A},$	$ V_O \le 5 V$			25			50	mV	
Output regulation	TJ = 25°C	$ V_0 \ge 5 V$		0.3%	0.5%		0.3%	1%		
Output regulation	$I_{O} = 10 \text{ mA to } 1.5 \text{ A}$	$ V_0 \le 5 V$			50			70	mV	
	10 = 10 IIIA to 1.5 A	$ V_0 \ge 5 V$			1%			1.5%		
Output-voltage change with temperature	T _J = MIN to MAX			0.6%			0.6%			
Output-voltage long-term drift	After 1000 h at T _J = MAX an	$d V_I - V_O = -40 V$		0.3%	1%		0.3%	1%		
Output noise voltage	f = 10 Hz to 10 kHz,	TJ = 25°C		0.003%			0.003%			
Minimum output	$ V_I - V_O \le 40 V$			2.5	5		2.5	10	mA	
current to maintain regulation	$ V_I - V_O \le 10 \text{ V}$			1.2	3		1.5	6		
	$ V_{I} - V_{O} \le 15 V$		1.5	2.2		1.5	2.2			
Peak output current	$ V_{I} - V_{O} \le 40 V,$	TJ = 25°C	0.24	0.4		0.15	0.4		A	
Adjustment-terminal current				65	100		65	100	μA	
Change in adjustment-terminal current	$V_I - V_O = -2.5 V \text{ to } -40 V,$ $I_O = 10 \text{ mA to MAX}$	T _J = 25°C,		2	5		2	5	μΑ	
Reference voltage (output to ADJ)	$V_{I} - V_{O} = -3 V \text{ to } -40 V,$	TJ = 25°C	-1.225	-1.25	-1.275	-1.213	-1.25	-1.287	V	
	$I_O = 10 \text{ mA to } 1.5 \text{ A},$ P \leq rated dissipation	$T_J = MIN$ to MAX	-1.2	-1.25	-1.3	-1.2	-1.25	-1.3	V	
Thermal regulation	Initial T _J = 25°C,	10-ms pulse		0.002	0.02		0.003	0.04	%/W	

[†] Unless otherwise noted, these specifications apply for the following test conditions $|V_I - V_O| = 5 V$ and $I_O = 0.5 A$. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. All characteristics are measured with a 0.1- μ F capacitor across the input and a 1- μ F capacitor across the output. Pulse-testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately.

[‡] Input regulation is expressed here as the percentage change in output voltage per 1-V change at the input.



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electrical characteristics, $T_J = 25^{\circ}C$

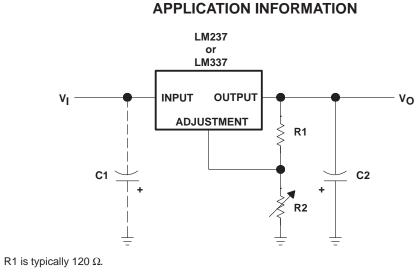
DADAMETED	TEST CONDITIONS [†]		LM237, LM337				
PARAMETER			MIN	TYP	MAX	UNIT	
Input regulation [‡]	$V_{I} - V_{O} = -3 V \text{ to } -40 V$			0.01	0.04	%/V	
	V _O = -10 V,	f = 120 Hz		60		dB	
Ripple rejection	$V_{O} = -10 \text{ V}, \qquad C_{ADJ} = 10 \ \mu\text{F},$	f = 120 Hz	66	77		uБ	
Output regulation	I _O = 10 mA to 1.5 A	V _O ≤ 5 V			50	mV	
Output regulation		V _O ≥ 5 V		0.3%	1%		
Output noise voltage	f = 10 Hz to 10 kHz			0.003%			
	$ V_{I} - V_{O} \le 40 V$			2.5	10	A	
Minimum output current to maintain regulation	$ V_{I} - V_{O} \le 10 V$			1.5	6	mA	
Deal and an and	VI – VO ≤ 15 V	1.5	2.2		٨		
Peak output current	$ V_{I} - V_{O} \le 40 V$	0.15	0.4		A		
Adjustment-terminal current				65	100	μA	
Change in adjustment-terminal current	$V_{I} - V_{O} = -2.5 V \text{ to } -40 V,$	$I_{O} = 10 \text{ mA to MAX}$		2	5	μA	
Reference voltage (output to ADJ)	$V_I - V_O = -3 V$ to $-40 V$, P \leq rated dissipation	l _O = 10 mA to 1.5 A,	-1.213	-1.25	-1.287	V	

[†] Unless otherwise noted, these specifications apply for the following test conditions $|V_I - V_O| = 5 V$ and $I_O = 0.5 A$. All characteristics are measured with a 0.1- μ F capacitor across the input and a 1- μ F capacitor across the output. Pulse-testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately.

[‡] Input regulation is expressed here as the percentage change in output voltage per 1-V change at the input.



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R2 = R1 $\left(\frac{-V_0}{-1.25} - 1\right)$ where V₀ is the output in volts.

C1 is a 1-µF solid tantalum capacitor required only if the regulator is more than 10 cm (4 in) from the power-supply filter capacitor. C2 is a 1-µF solid tantalum or 10-µF aluminum electrolytic capacitor required for stability.

Figure 1. Adjustable Negative-Voltage Regulator

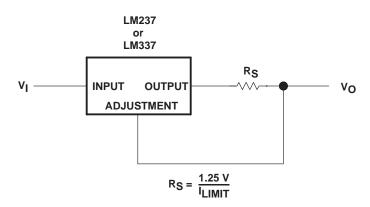


Figure 2. Current-Limiting Circuit



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